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Part Number:

0737802253

Status:

Active

Overview:

HDM Backplane Connector System

Description:

HDM Board-to-Board Daughtercard Receptacle, Vertical, Signal Module, 72 Circuits, Mounted Height 13.00mm, Pin Length 3.50mm, Press-Fit



Documents:

[Drawing \(PDF\)](#)

[Product Specification PS-73780-999-001 \(PDF\)](#)

[Test Summary TS-73670-990-001 \(PDF\)](#)

[RoHS Certificate of Compliance \(PDF\)](#)

Agency Certification	
UL	E29179
General	
Product Family	Backplane Connectors
Series	73780
Application	Daughtercard, Mezzanine
Comments	Press-Fit Tail, Press-Fit Tail
Component Type	PCB Receptacle
Overview	HDM Backplane Connector System
Product Name	HDM
UPC	756054167946
Physical	
Circuits (Loaded)	72
Circuits (maximum)	72
Color - Resin	Black
Durability (mating cycles max)	250
First Mate / Last Break	No
Flammability	94V-0
Guide to Mating Part	No
Keying to Mating Part	None
Material - Metal	Copper-Nickel-Tin
Material - Plating Mating	Gold
Material - Plating Termination	Tin-Lead
Material - Resin	High Temperature Thermoplastic
Net Weight	9.498/g
Number of Columns	12
Number of Pairs	Open Pin Field
Number of Rows	6
Orientation	Vertical
PC Tail Length	3.50mm
PCB Locator	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
Packaging Type	Tube
Pitch - Mating Interface	2.00mm
Pitch - Termination Interface	2.00mm
Plating min - Mating	0.762µm
Plating min - Termination	0.889µm
Polarized to PCB	No
Stackable	Yes
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	-55° to +105°C
Termination Interface: Style	Through Hole - Compliant Pin
Electrical	

EU ELV

Not Relevant

EU RoHS

Compliant

China RoHS

Green Image

REACH SVHC

Not Contained Per - ED/71/2019 (16 July 2019)

Halogen-Free Status

Low-Halogen

For more information, please visit

Contact US

China ROHS

ELV

RoHS Phthalates

Green Image

Not Relevant

Not Contained

Search Parts in this Series

73780 Series

Mates With

HDM Board-to-Board Backplane Header [73642](#) , [73643](#) , [73644](#) , [73942](#) , [73943](#) , [73944](#) , [74349](#) , [74428](#). HDM Board-to-Board Stacking Header [73769](#) , [73770](#) , [73782](#) , [73783](#) , [73771](#)

Current - Maximum per Contact	15.0A, 1.0A
Data Rate	1.0 Gbps
Real Signals (per 25mm)	75
Shielded	No
Voltage - Maximum	250V AC
Solder Process Data	
Lead-freeProcess Capability	N/A
Material Info	
Reference - Drawing Numbers	
Product Specification	PS-73780-999-001
Sales Drawing	SD-73780-001-001
Test Summary	TS-73670-990-001

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